

## XPT IGBT

preliminary

$$V_{CES} = 1200V$$

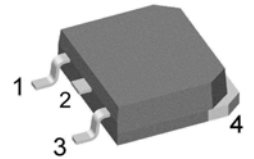
$$I_{C25} = 20A$$

$$V_{CE(sat)} = 1.8V$$

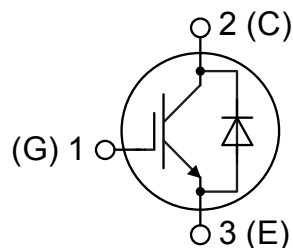
Copack

Part number

IXA12IF1200TC



Backside: collector

**Features / Advantages:**

- Easy paralleling due to the positive temperature coefficient of the on-state voltage
- Rugged XPT design (Xtreme light Punch Through) results in:
  - short circuit rated for 10  $\mu$ sec.
  - very low gate charge
  - low EMI
  - square RBSOA @ 3x Ic
- Thin wafer technology combined with the XPT design results in a competitive low VCE(sat)
- SONIC™ diode
  - fast and soft reverse recovery
  - low operating forward voltage

**Applications:**

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans

**Package:** TO-268AA (D3Pak)

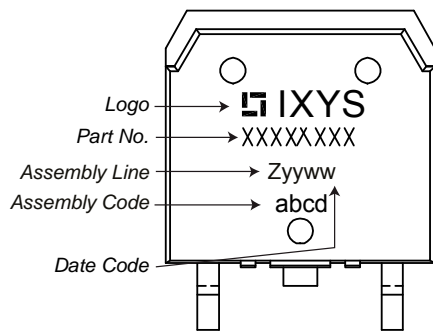
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

| IGBT          |  |  |                                | Ratings |          |               |    |
|---------------|--|--|--------------------------------|---------|----------|---------------|----|
| Symbol        | Definition                             | Conditions   | min.                           | typ.    | max.     | Unit          |    |
| $V_{CES}$     | collector emitter voltage              | $T_{VJ} = 25^{\circ}\text{C}$  |                                |         | 1200     | V             |    |
| $V_{GES}$     | max. DC gate voltage                   |  |                                |         | $\pm 20$ | V             |    |
| $V_{GEM}$     | max. transient gate emitter voltage    |  |                                |         | $\pm 30$ | V             |    |
| $I_{C25}$     | collector current                      | $T_C = 25^{\circ}\text{C}$   |                                |         | 20       | A             |    |
| $I_{C100}$    |  | $T_C = 100^{\circ}\text{C}$  |                                |         | 13       | A             |    |
| $P_{tot}$     | total power dissipation                | $T_C = 25^{\circ}\text{C}$   |                                |         | 85       | W             |    |
| $V_{CE(sat)}$ | collector emitter saturation voltage   | $I_C = 10\text{A}; V_{GE} = 15\text{V}$  |                                | 1.8     | 2.1      | V             |    |
|               |  |  |                                | 2.1     |          | V             |    |
| $V_{GE(th)}$  | gate emitter threshold voltage         | $I_C = 0.3\text{mA}; V_{GE} = V_{CE}$  | 5.4                            | 5.9     | 6.5      | V             |    |
| $I_{CES}$     | collector emitter leakage current      | $V_{CE} = V_{CES}; V_{GE} = 0\text{V}$   |                                |         | 0.1      | mA            |    |
|               |  |  |                                | 0.1     |          | mA            |    |
| $I_{GES}$     | gate emitter leakage current           | $V_{GE} = \pm 20\text{V}$  |                                |         | 500      | nA            |    |
| $Q_{G(on)}$   | total gate charge                      | $V_{CE} = 600\text{V}; V_{GE} = 15\text{V}; I_C = 10\text{A}$  |                                | 27      |          | nC            |    |
| $t_{d(on)}$   | turn-on delay time                     | inductive load<br>$V_{CE} = 600\text{V}; I_C = 10\text{A}$<br>$V_{GE} = \pm 15\text{V}; R_G = 100\Omega$ |                                | 70      |          | ns            |    |
| $t_r$         | current rise time                      |  | $T_{VJ} = 125^{\circ}\text{C}$ |         | 40       |               | ns |
| $t_{d(off)}$  | turn-off delay time                    |  |                                |         | 250      |               | ns |
| $t_f$         | current fall time                      |  |                                |         | 100      |               | ns |
| $E_{on}$      | turn-on energy per pulse               |  |                                |         | 1.1      |               | mJ |
| $E_{off}$     | turn-off energy per pulse              |  |                                |         | 1.1      |               | mJ |
| <b>RBSOA</b>  | reverse bias safe operating area       | $V_{GE} = \pm 15\text{V}; R_G = 100\Omega$   |                                |         |          |               |    |
| $I_{CM}$      |  | $V_{CEmax} = 1200\text{V}$   |                                |         | 30       | A             |    |
| <b>SCSOA</b>  | short circuit safe operating area      | $V_{CEmax} = 900\text{V}$  |                                |         |          |               |    |
| $t_{sc}$      | short circuit duration                 | $V_{CE} = 900\text{V}; V_{GE} = \pm 15\text{V}$  |                                |         | 10       | $\mu\text{s}$ |    |
| $I_{sc}$      | short circuit current                  | $R_G = 100\Omega; \text{non-repetitive}$   |                                | 40      |          | A             |    |
| $R_{thJC}$    | thermal resistance junction to case    |  |                                |         | 1.5      | K/W           |    |
| $R_{thCH}$    | thermal resistance case to heatsink    |  |                                | 0.15    |          | K/W           |    |
| <b>Diode</b>  |  |  |                                |         |          |               |    |
| $V_{RRM}$     | max. repetitive reverse voltage        | $T_{VJ} = 25^{\circ}\text{C}$  |                                |         | 1200     | V             |    |
| $I_{F25}$     | forward current                        | $T_C = 25^{\circ}\text{C}$   |                                |         | 22       | A             |    |
| $I_{F100}$    |  | $T_C = 100^{\circ}\text{C}$  |                                |         | 14       | A             |    |
| $V_F$         | forward voltage                        | $I_F = 10\text{A}$   |                                |         | 2.20     | V             |    |
|               |  |  |                                | 1.95    |          | V             |    |
| $I_R$         | reverse current                        | $V_R = V_{RRM}$  |                                |         | *        | mA            |    |
|               | * not applicable, see Ices value above |  |                                |         | *        | mA            |    |
| $Q_{rr}$      | reverse recovery charge                | $V_R = 600\text{V}$<br>$-di_F/dt = -250\text{A}/\mu\text{s}$<br>$I_F = 10\text{A}; V_{GE} = 0\text{V}$   |                                | 1.3     |          | $\mu\text{C}$ |    |
| $I_{RM}$      | max. reverse recovery current          |  | $T_{VJ} = 125^{\circ}\text{C}$ |         | 10.5     |               | A  |
| $t_{rr}$      | reverse recovery time                  |  |                                |         | 350      |               | ns |
| $E_{rec}$     | reverse recovery energy                |  |                                |         | 0.35     |               | mJ |
| $R_{thJC}$    | thermal resistance junction to case    |  |                                |         | 1.8      | K/W           |    |
| $R_{thCH}$    | thermal resistance case to heatsink    |  |                                | 0.15    |          | K/W           |    |

preliminary

| Package TO-268AA (D3Pak) |                              |              | Ratings |      |      |      |
|--------------------------|------------------------------|--------------|---------|------|------|------|
| Symbol                   | Definition                   | Conditions   | min.    | typ. | max. | Unit |
| $I_{RMS}$                | RMS current                  | per terminal |         |      | 70   | A    |
| $T_{VJ}$                 | virtual junction temperature |              | -40     |      | 150  | °C   |
| $T_{op}$                 | operation temperature        |              | -40     |      | 125  | °C   |
| $T_{stg}$                | storage temperature          |              | -40     |      | 150  | °C   |
| <b>Weight</b>            |                              |              |         | 5    |      | g    |
| $F_C$                    | mounting force with clip     |              | 20      |      | 120  | N    |

### Product Marking



### Part number

- I = IGBT
- X = XPT IGBT
- A = Gen 1 / std
- 12 = Current Rating [A]
- IF = Copack
- 1200 = Reverse Voltage [V]
- TC = TO-268AA (D3Pak) (2)

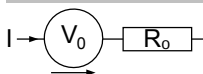
| Ordering | Part Number   | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|---------------|--------------------|---------------|----------|----------|
| Standard | IXA12IF1200TC | IXA12IF1200TC      | Tube          | 30       | 508475   |

| Similar Part  | Package      | Voltage class |
|---------------|--------------|---------------|
| IXA12IF1200HB | TO-247AD (3) | 1200          |
| IXA12IF1200PB | TO-220AB (3) | 1200          |

### Equivalent Circuits for Simulation

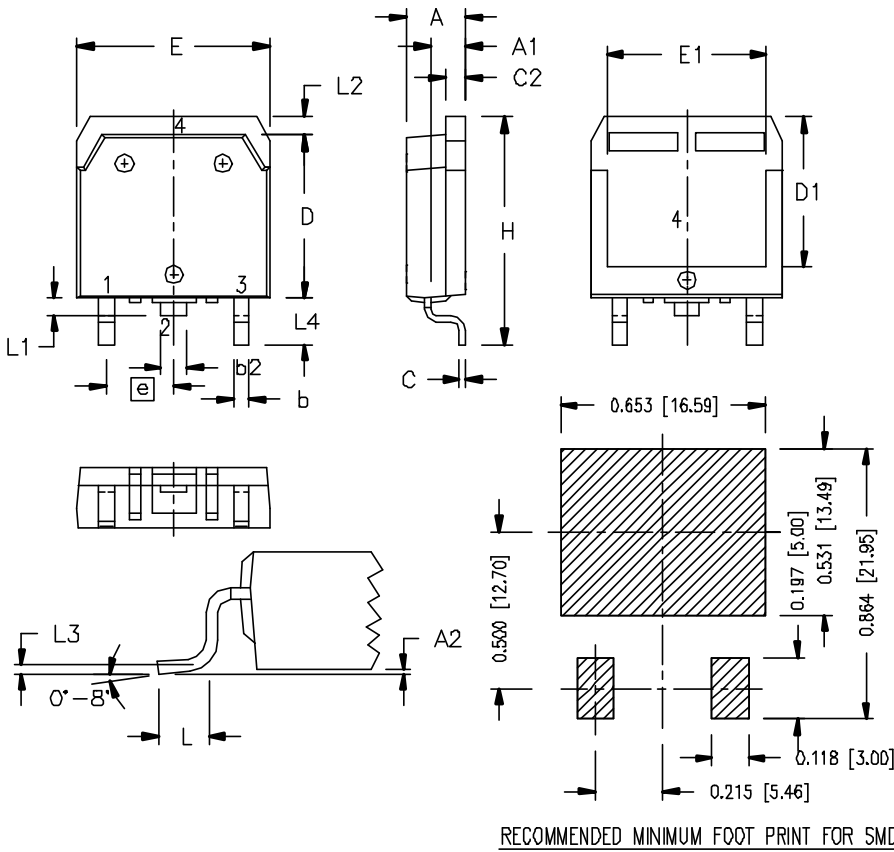
\* on die level

$T_{VJ} = 150\text{ °C}$

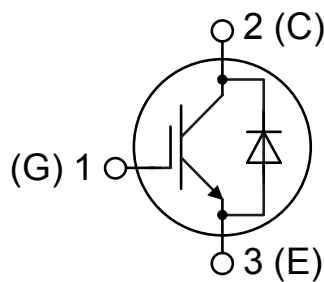


|                                 | IGBT | Diode |    |
|---------------------------------|------|-------|----|
| $V_{0\ max}$ threshold voltage  | 1.1  | 1.25  | V  |
| $R_{0\ max}$ slope resistance * | 153  | 85    | mΩ |

**Outlines TO-268AA (D3Pak)**



| Dim. | Millimeter |       | Inches    |       |
|------|------------|-------|-----------|-------|
|      | min        | max   | min       | max   |
| A    | 4.90       | 5.10  | 0.193     | 0.201 |
| A1   | 2.70       | 2.90  | 0.106     | 0.114 |
| A2   | 0.02       | 0.25  | 0.001     | 0.100 |
| b    | 1.15       | 1.45  | 0.045     | 0.057 |
| b2   | 1.90       | 2.10  | 0.075     | 0.083 |
| C    | 0.40       | 0.65  | 0.016     | 0.026 |
| C2   | 1.45       | 1.60  | 0.057     | 0.063 |
| D    | 13.80      | 14.00 | 0.543     | 0.551 |
| D1   | 12.40      | 12.70 | 0.488     | 0.500 |
| E    | 15.85      | 16.05 | 0.624     | 0.632 |
| E1   | 13.30      | 13.60 | 0.524     | 0.535 |
| e    | 5.45 BSC   |       | 0.215 BSC |       |
| H    | 18.70      | 19.10 | 0.736     | 0.752 |
| L    | 2.40       | 2.70  | 0.094     | 0.106 |
| L1   | 1.20       | 1.40  | 0.047     | 0.055 |
| L2   | 1.00       | 1.15  | 0.039     | 0.045 |
| L3   | 0.25 BSC   |       | 0.100 BSC |       |
| L4   | 3.80       | 4.10  | 0.150     | 0.161 |



## IGBT

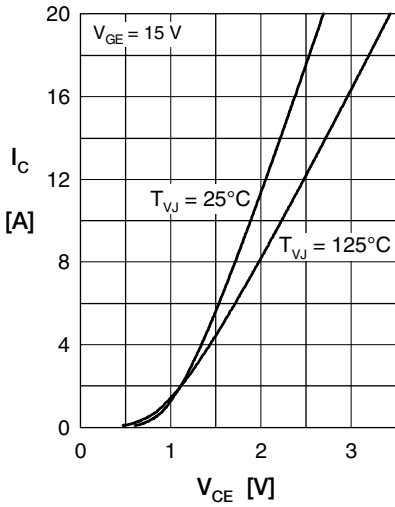


Fig. 1 Typ. output characteristics

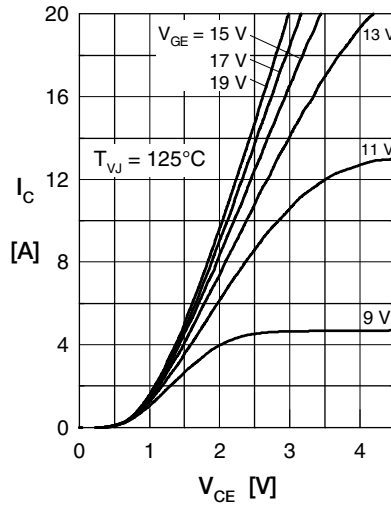


Fig. 2 Typ. output characteristics

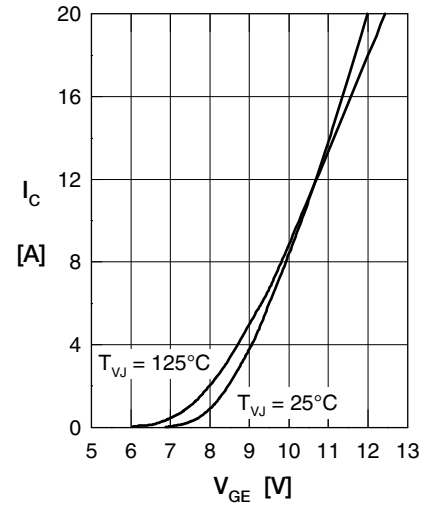


Fig. 3 Typ. transfer characteristics

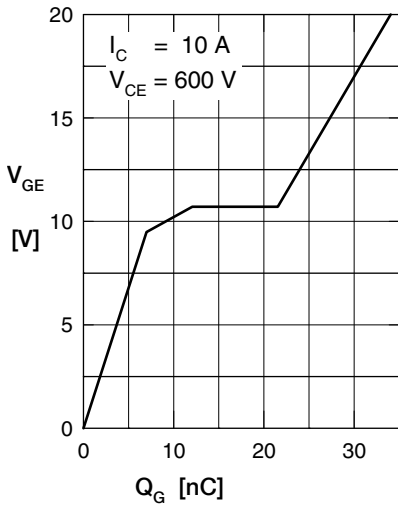


Fig. 4 Typ. turn-on gate charge

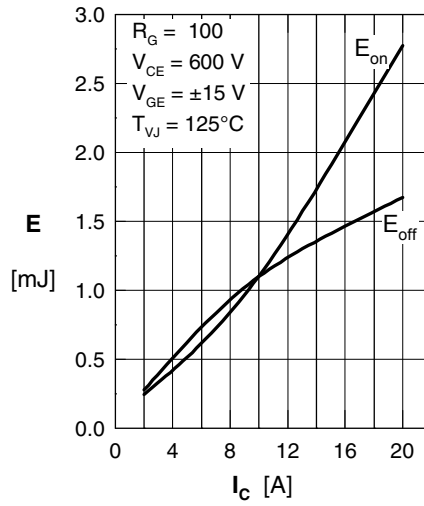


Fig. 5 Typ. switching energy vs. collector current

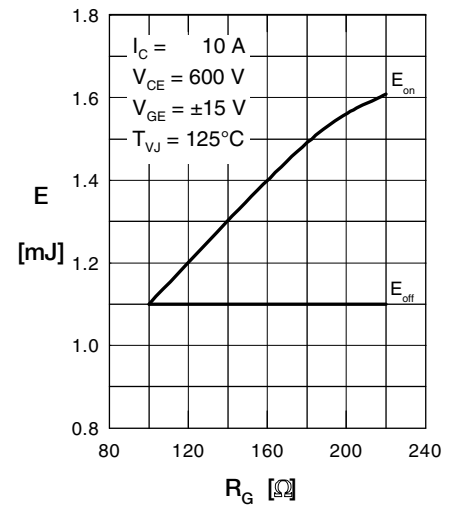


Fig. 6 Typ. switching energy vs. gate resistance

Fig. 7 Typ. transient thermal impedance junction to case

## Diode

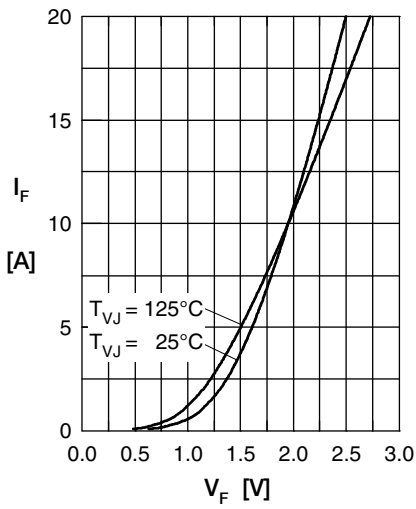


Fig. 1 Typ. forward current versus  $V_F$

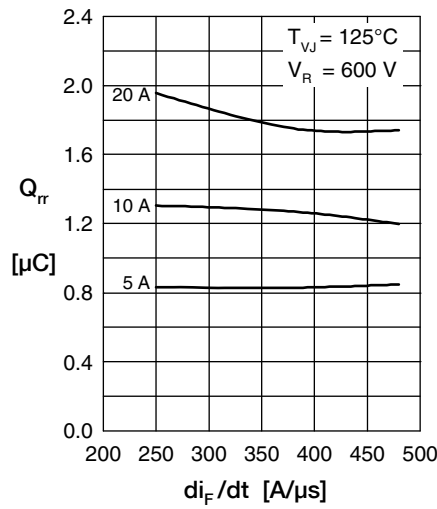


Fig. 2 Typical reverse recov. charge  $Q_{rr}$  versus  $di_F/dt$

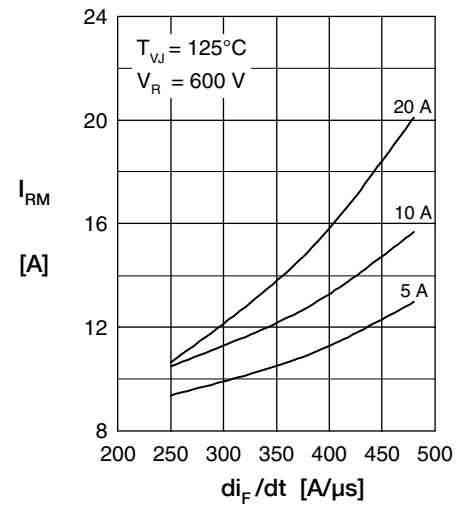


Fig. 3 Typ: peak reverse current  $I_{RM}$  versus  $di_F/dt$

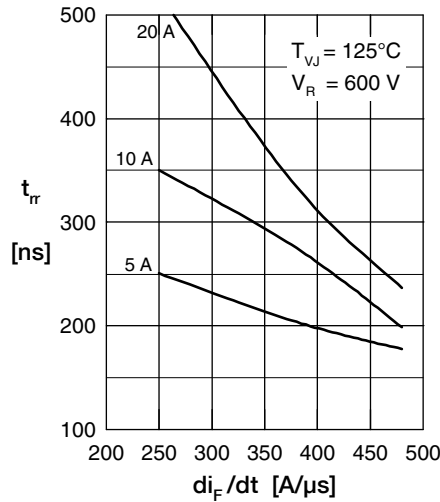


Fig. 4 Dynamic parameters  $Q_{rr}$ ,  $I_{RM}$  versus  $T_{VJ}$

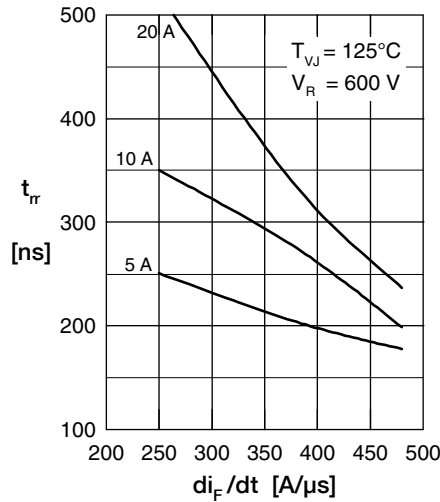


Fig. 5 Typ. recovery time  $t_{rr}$  versus  $di_F/dt$

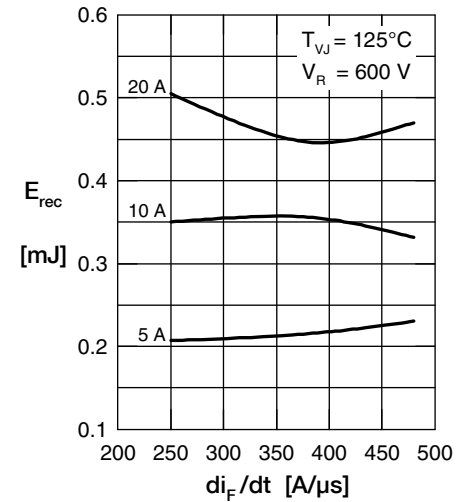


Fig. 6 Typ. recovery energy  $E_{rec}$  vs.  $di_F/dt$

Fig. 7 Typ. transient thermal impedance junction to case



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